



Solenoid Monitor Integrated Circuit (IC)

The 33811 is a 5 channel Solenoid Monitor IC that is used to verify proper electrical and mechanical solenoid operation. The IC contains five solenoid driver voltage monitoring stages and a serial peripheral interface (SPI) for fault communication and setup. The IC has the ability to determine the correct movement of solenoid armatures by analyzing the variation in the voltage profile, across the solenoid driver MOSFET, which represents the actual solenoid current profile.

These features, along with cost effective packaging, make the 33811 ideal for powertrain solenoid monitoring applications.

Features

- Typical operating voltage range, $10.5 < V_{PWR} < 15.5$ volts
- Interfaces to 3.3 and 5 volt microprocessors via SPI protocol
- Reset pin to initialize all 5 fault outputs
- Internal voltage regulator
- Internal oscillator
- Unique solenoid current profile detection circuitry
- Pb-free packaging designated by suffix code EG

33811

SOLENOID MONITOR



EG SUFFIX (PB_FREE)
98ASB42567B
16-PIN SOICW

ORDERING INFORMATION

Device	Temperature Range (T _A)	Package
MCZ33811EG/R2	-40°C to 125°C	16 SOICW

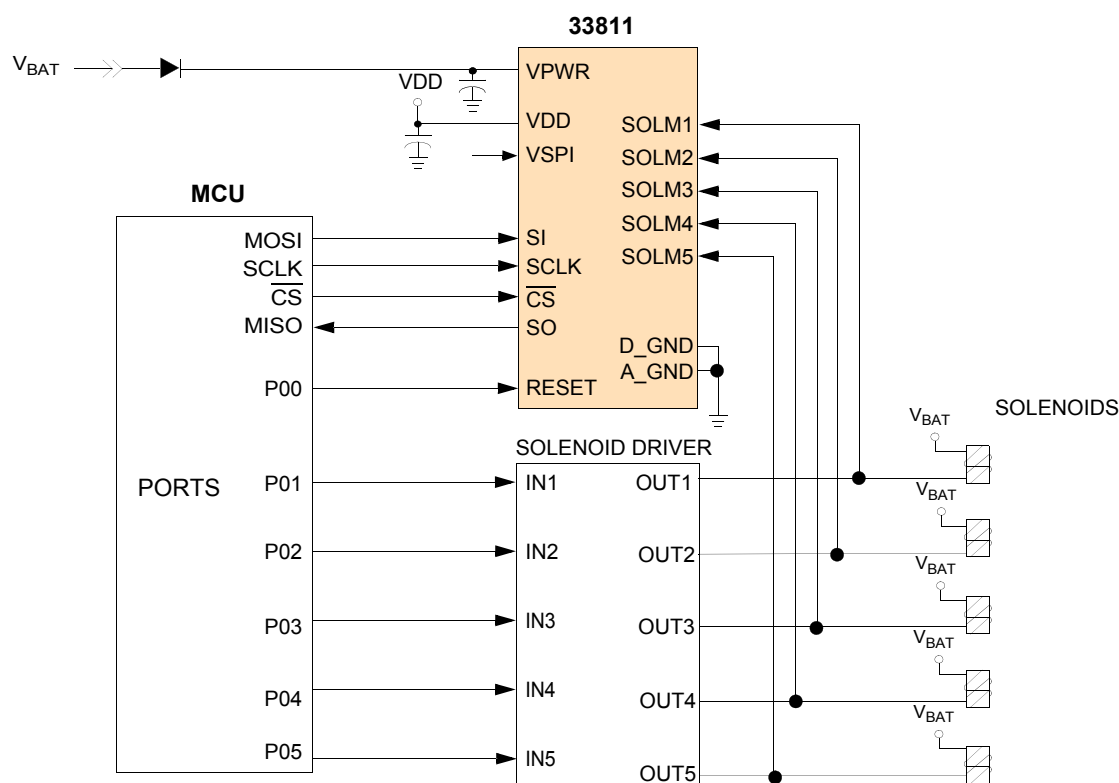


Figure 1. 33811 Simplified Application Diagram

* This document contains certain information on a new product. Specifications and information herein are subject to change without notice.

INTERNAL BLOCK DIAGRAM

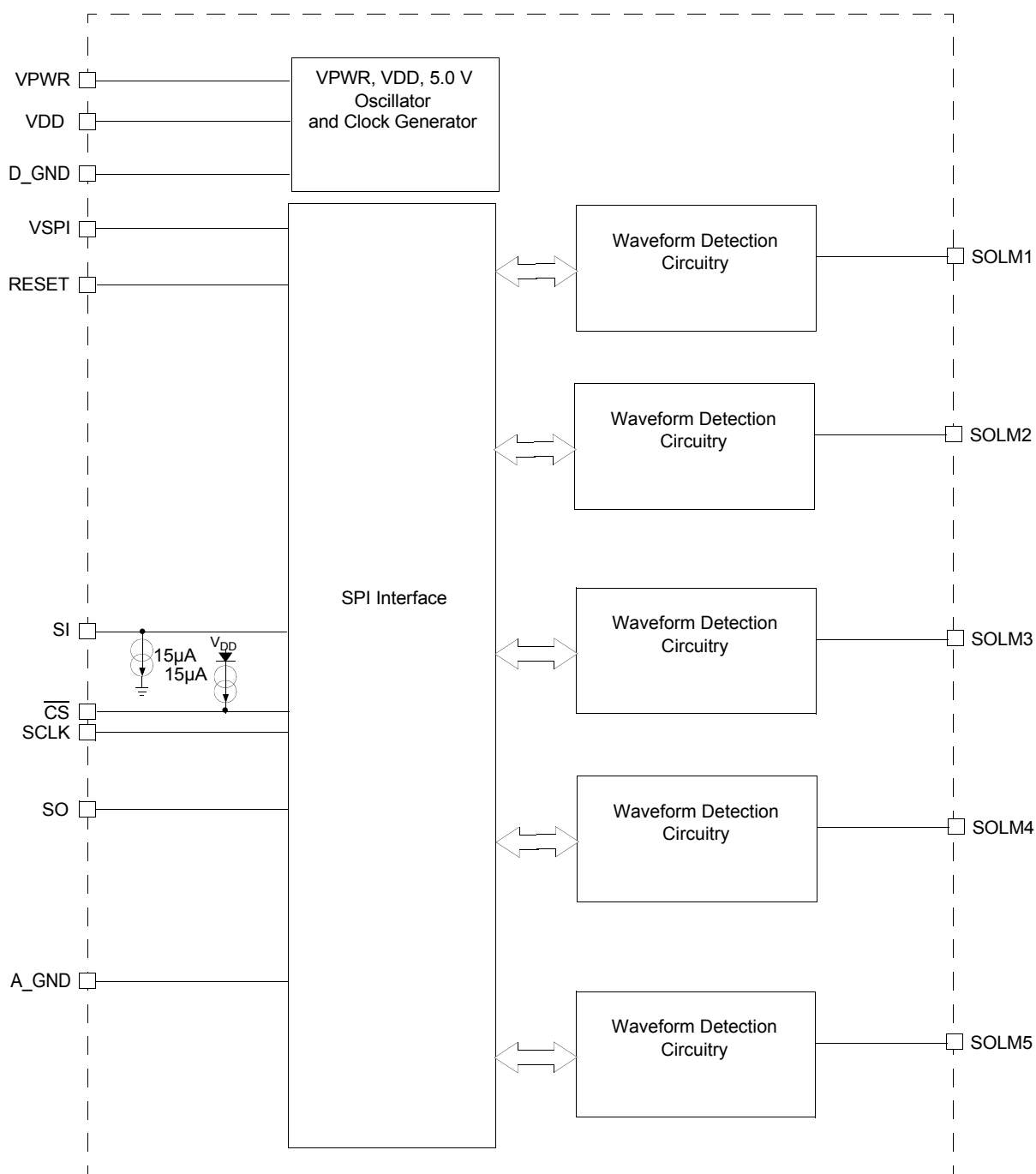


Figure 2. 33811 Simplified Internal Block Diagram

PIN CONNECTIONS

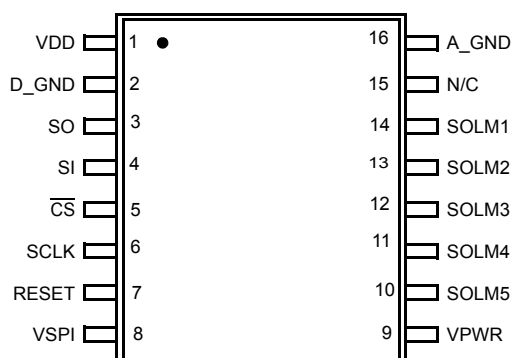


Figure 3. 33811 Pin Connections

Table 1. 33811 Pin Definitions

A functional description of each pin can be found in the Functional Pin Description section beginning on [page 11](#).

Pin Number	Pin Name	Pin Function	Formal Name	Definition
1	VDD	Power	Digital Voltage Supply	The VDD pin is the digital logic supply voltage used internally in the IC.
2	D_GND	Ground	Digital Ground	Digital ground for the internal control circuits of the IC. This ground should be used for decoupling of the VDD supply.
3	SO	Output	Serial Output Data	The SO output pin is used to transmit serial data from the device to the MCU. The SO pin remains tri-state until selected by the active low \overline{CS} . The serial output data is available to be latched by the MCU on the rising edge of SCLK. The SO data transitions on falling edge of the SCLK.
4	SI	Input	Serial Input Data	The SI input pin is used to receive serial data from the MCU. The serial input data is latched on the rising edge of SCLK, and the input data transitions on the falling edge of SCLK.
5	\overline{CS}	Input	Chip Select	The Chip Select input pin is an active low signal sent by the MCU to indicate that the device is being addressed. This input requires CMOS logic levels and has an internal active pull-up current source.
6	SCLK	Input	Serial Clock Input	The SCLK input pin is used to clock in and out the serial data on the SI and SO pins while being addressed by the \overline{CS} . The SCLK signal consists of a 50% duty cycle with CMOS logic levels. Input data is latched by the device on the rising edge of SCLK while output data is changed on the falling edge. SCLK is ignored by the device while \overline{CS} is high.
7	RESET	Input	Reset Input	The RESET pin, when pulled high, clears any fault bits and causes the Serial Output pin to be tri-stated. The RESET pin operates at the CMOS levels dictated by the VDD line and the state of the VSPI pin.
8	VSPI	Input	V_{SPI}	The VSPI pin determines the voltage levels for the SPI interface. It must be connected to the same voltage supply (+5 volts or +3.3 Volts) as the MCU's SPI interface.
9	VPWR	Power	Analog Voltage Supply	The analog voltage supply provides the power for all the input amplifiers and other analog circuitry in the IC.
10	SOLM5	Input	Solenoid Monitor 5	The Solenoid Monitor Input is connected to the solenoid coil at the output driver. It monitors the current waveform through the solenoid coil as it appears as a voltage across the output driver MOSFET.
11	SOLM4	Input	Solenoid Monitor 4	The Solenoid Monitor Input is connected to the solenoid coil at the output driver. It monitors the current waveform through the solenoid coil as it appears as a voltage across the output driver MOSFET.

Table 1. 33811 Pin Definitions (continued)

A functional description of each pin can be found in the Functional Pin Description section beginning on [page 11](#).

Pin Number	Pin Name	Pin Function	Formal Name	Definition
12	SOLM3	Input	Solenoid Monitor 3	The Solenoid Monitor Input is connected to the solenoid coil at the output driver. It monitors the current waveform through the solenoid coil as it appears as a voltage across the output driver MOSFET.
13	SOLM2	Input	Solenoid Monitor 2	The Solenoid Monitor Input is connected to the solenoid coil at the output driver. It monitors the current waveform through the solenoid coil as it appears as a voltage across the output driver MOSFET.
14	SOLM1	Input	Solenoid Monitor 1	The Solenoid Monitor Input is connected to the solenoid coil at the output driver. It monitors the current waveform through the solenoid coil as it appears as a voltage across the output driver MOSFET.
15	N/C	No Connect	No Connect	This pin is not to be used and must be left open in any design.
16	A_GND	Ground	Analog Ground	The Analog Ground is the return for the VDD and VPWR supply.

ELECTRICAL CHARACTERISTICS

MAXIMUM RATINGS

Table 2. Maximum Ratings

All voltages are with respect to ground unless otherwise noted. Exceeding these ratings may cause a malfunction or permanent damage to the device.

Ratings	Symbol	Value	Unit
ELECTRICAL RATINGS			
Supply Voltage (continuous) VPWR VDD VSPI	V _{PWR} V _{DD} V _{SPI}	-1.5 to 25 -0.3 to 7.0 -0.3 to 7.0	V _{DC}
Supply Voltage (transient) on VPWR	V _{PWRMAX}	-1.5 to 50	V _{DC}
\overline{CS} , SI, SO, SCLK, RESET	—	-0.3 to V _{SPI}	V _{DC}
Solenoid Monitor Inputs Maximum Voltage (5ms. maximum duration)	V _{INJMXMAX}	64	V _{DC}
Frequency of SPI Operation (V _{DD} = 5.0V) ⁽¹⁾	—	3.2	MHz
ESD Voltage ⁽²⁾ Human Body Model ⁽³⁾ Machine Model	V _{ESD1} V _{ESD2}	±2000 ±200	V
THERMAL RATINGS			
Peak Package Reflow Temperature During Reflow ^{(4), (5)}	T _{PPRT}	Note 5	°C
Storage Temperature	T _{STG}	-55 to 150	°C
Operating Ambient Temperature	T _A	-40 to 125	°C
Operating Junction Temperature	T _J	-40 to 150	°C

Notes

1. This parameter is guaranteed by design but is not production tested.
2. ESD testing is performed in accordance with the Human Body Model (HBM) (Per AEC-Q100-002, C_{ZAP} = 100pF, R_{ZAP} = 1500Ω) and the Machine Model (MM) (Per AEC-Q100-002, C_{ZAP} = 200pF, R_{ZAP} = 0Ω). ESD data available upon request.
3. All pins when tested individually.
4. Pin soldering temperature limit is for 10 seconds maximum duration. Not designed for immersion soldering. Exceeding these limits may cause malfunction or permanent damage to the device.
5. Freescale's Package Reflow capability meets Pb-free requirements for JEDEC standard J-STD-020C. For Peak Package Reflow Temperature and Moisture Sensitivity Levels (MSL), Go to www.freescale.com, search by part number [e.g. remove prefixes/suffixes and enter the core ID to view all orderable parts. (i.e. MC33xxx enter 33xxx), and review parametrics.

STATIC ELECTRICAL CHARACTERISTICS

Table 3. Static Electrical Characteristics

Characteristics noted under conditions $7.0V \leq V_{PWR} \leq 17V$, $-40^{\circ}C \leq T_A \leq 125^{\circ}C$, GND = 0V, unless otherwise noted. Typical values noted reflect the approximate parameter means at $T_A = 25^{\circ}C$ under nominal conditions, unless otherwise noted.

Characteristic	Symbol	Min	Typ	Max	Unit
POWER INPUT (VPWR, IPWR, IVDD, VDD, IDD)					
Analog Supply Voltage Range Fully Operational	$V_{PWR(FO)}$	10.5	–	15.5	V
Digital Logic Supply Voltage Range Fully Operational	$V_{DD(FO)}$	4.75	5.0	5.25	V
SPI Voltage Supply Voltage Range Fully Operational	$V_{SPI(FO)}$	3.0	3.3 5.0	5.25	V
Supply Current from VPWR All Outputs Disabled (Normal & Default Mode) $V_{PWR} = 17V$	$I_{PWR(ON)}$	–	1.0	5.0	mA
Supply Current from VDD All Outputs Disabled (Normal & Default Mode) $V_{DD} = 5.5V$	$I_{DD(ON)}$		1.0	5.0	mA
Positive Threshold Voltage Point A ($10.5V \leq V_{PWR} \leq 15.5V$)	$V^{+}_{TH_A}$	0	0.5	1.0	mV
Positive Threshold Voltage Point A with Offset ($10.5V \leq V_{PWR} \leq 15.5V$)	$V^{+}_{TH_A_OFFSET}$			1.5	mV
Positive Threshold Voltage Point B ($10.5V \leq V_{PWR} \leq 15.5V$)	$V^{+}_{TH_B}$	1.5	3.0	4.5	mV
Negative Threshold Voltage ($10.5V \leq V_{PWR} \leq 15.5V$)	V^{-}_{TH}	0	-0.5	-1.0	mV
Negative Threshold Voltage with Offset ($10.5V \leq V_{PWR} \leq 15.5V$)	$V^{-}_{TH_OFFSET}$			-1.5	mV
Logic Supply Voltage	V_{DD}	3.0	–	5.5	V
Logic Supply Current Static Condition	I_{DD}	250	400	700	μA

SPI DIGITAL INTERFACE (V_{IH} , V_{IL} , V_{HYS} , C_{IN} , LOGICSS)

Input Logic High-voltage Thresholds ⁽⁸⁾	V_{IH}	$0.7 \times V_{SPI}$	–	$V_{SPI} + 0.3$	V
Input Logic Low-voltage Thresholds ⁽⁸⁾	V_{IL}	GND - 0.3	–	$0.2 \times V_{SPI}$	V
Input Logic Voltage Hysteresis ⁽⁸⁾	V_{HYS}	100	–	300	mV
Input Logic Capacitance ⁽⁹⁾	C_{IN}	–	–	20	pF

Notes

- Output fault detection thresholds with outputs programmed OFF. Output fault detect thresholds are the same for output open and shorts.
- This parameter is guaranteed by design, however is not production tested.
- Parameter applies to SI, RESET, \overline{CS} and is guaranteed by design.
- Undervoltage thresholds minimum and maximum include hysteresis.

Table 3. Static Electrical Characteristics

Characteristics noted under conditions $7.0\text{V} \leq V_{\text{PWR}} \leq 17\text{V}$, $-40^\circ\text{C} \leq T_A \leq 125^\circ\text{C}$, $\text{GND} = 0\text{V}$, unless otherwise noted. Typical values noted reflect the approximate parameter means at $T_A = 25^\circ\text{C}$ under nominal conditions, unless otherwise noted.

Characteristic	Symbol	Min	Typ	Max	Unit
Normal Mode Input Logic Pull-down Current 0.8V to 5.0V (SI)	I_{SPIPD}	5.0	10	25	μA
$\overline{\text{CS}}$, RESET Pull-up Current ($\overline{\text{CS}}$, RESET = 0)	$I_{\text{DEFAULTPU}}$	-5.0	-10	-25	μA
SCLK, Tri-state SO Output 0.0 V to 5.0 V	$I_{\text{SCK}}, I_{\text{TRISO}}$	-10	–	10	μA
$\overline{\text{CS}}$ Input Current $\overline{\text{CS}} = V_{\text{SPI}}$	$I_{\overline{\text{CS}}}$	-10	–	10	μA
$\overline{\text{CS}}$ Leakage Current to V_{SPI} $\overline{\text{CS}} = 5.0\text{V}$, $V_{\text{SPI}} = 0.0\text{V}$	$I_{\overline{\text{CS}}(\text{LKG})}$	–	–	10	μA
SO High-State Output Voltage $I_{\text{SOHIGH}} = -1.0\text{mA}$	V_{SOHIGH}	$V_{\text{SPI}} - 0.4$	–	–	V
SO Low-State Output Voltage $I_{\text{SOLOW}} = 1.0\text{mA}$	V_{SOLOW}	–	–	0.4	V
Solenoid Monitor Input Pull-up Current ($V_{\text{SOLM}} = 0\text{V}$)	$I_{\text{SOLM_PU}}$	-2.5	-5	-12.5	μA
Solenoid Monitor Input Leakage Current ($V_{\text{SOLM}} = 64\text{V}$)	$I_{\text{SOLM_LKG}}$	-10	–	10	μA

DYNAMIC ELECTRICAL CHARACTERISTICS

Table 4. Dynamic Electrical Characteristics

Characteristics noted under conditions $10.5V \leq V_{PWR} \leq 15.5V$, $-40^{\circ}C \leq T_A \leq 125^{\circ}C$, $GND = 0V$, unless otherwise noted. Typical values noted reflect the approximate parameter means at $T_A = 25^{\circ}C$ under nominal conditions, unless otherwise noted.

Characteristic	Symbol	Min	Typ	Max	Unit
SPI DIGITAL INTERFACE TIMING⁽¹⁰⁾					
Required High State Duration on RESET for Reset to occur ⁽¹¹⁾	t_{RESET}	1.0	—	—	μs
Falling Edge of \overline{CS} to Rising Edge of SCLK Required Setup Time	t_{LEAD}	100	—	—	ns
Falling Edge of SCLK to Rising Edge of \overline{CS} Required Setup Time	t_{LAG}		0	50	ns
SI to Rising Edge of SCLK Required Setup Time	$t_{SI(SU)}$	16	—	—	ns
Rising Edge of SCLK to SI Required Hold Time	$t_{SI(HOLD)}$	20	—	—	ns
SI, \overline{CS} , SCLK Signal Rise Time ⁽¹²⁾	$t_{R(SI)}$	—	5.0	—	ns
SI, \overline{CS} , SCLK Signal Fall Time ⁽¹²⁾	$t_{F(SI)}$	—	5.0	—	ns
Time from Falling Edge of \overline{CS} to SO Low-impedance ⁽¹³⁾	$t_{SO(EN)}$	—	65	80	ns
Time from Rising Edge of \overline{CS} to SO High-impedance ⁽¹⁴⁾	$t_{SO(DIS)}$	—	—	55	ns
Time from Falling Edge of SCLK to SO Data Valid ⁽¹⁵⁾	t_{VALID}	—	65	90	ns
Sequential Transfer Rate Time required between data transfers	t_{STR}			1.0	μs
Input Capacitance (SI, SCLK)	C_{INPUT}		7	15	pF
Load Capacitance (SO)	C_{LOAD}			200	pF
Tri-state Output Capacitance (SO)	$C_{TRI-STATE}$			20	pF

WAVEFORM DETECTION TIMINGS

Start of Activation Filter Time ⁽¹⁶⁾	t_{BEGIN}	200	400	600	μs
Detection Window Time	t_{WINDOW}	40	53	66	ms
Sample Time	t_{SAM}		72		μs

Notes:

- These parameters are guaranteed by design. Production test equipment uses 3.2MHz, 5.0V SPI interface.
- This parameter is guaranteed by design, however it is not production tested.
- Rise and Fall time of incoming SI, \overline{CS} , and SCLK signals suggested for design consideration to prevent the occurrence of double pulsing.
- Time required for valid output status data to be available on SO pin.
- Time required for output states data to be terminated at SO pin.
- Time required to obtain valid data out from SO following the fall of SCLK with 200pF load.
- 9 μs guard band included in maximum limit

TIMING DIAGRAMS

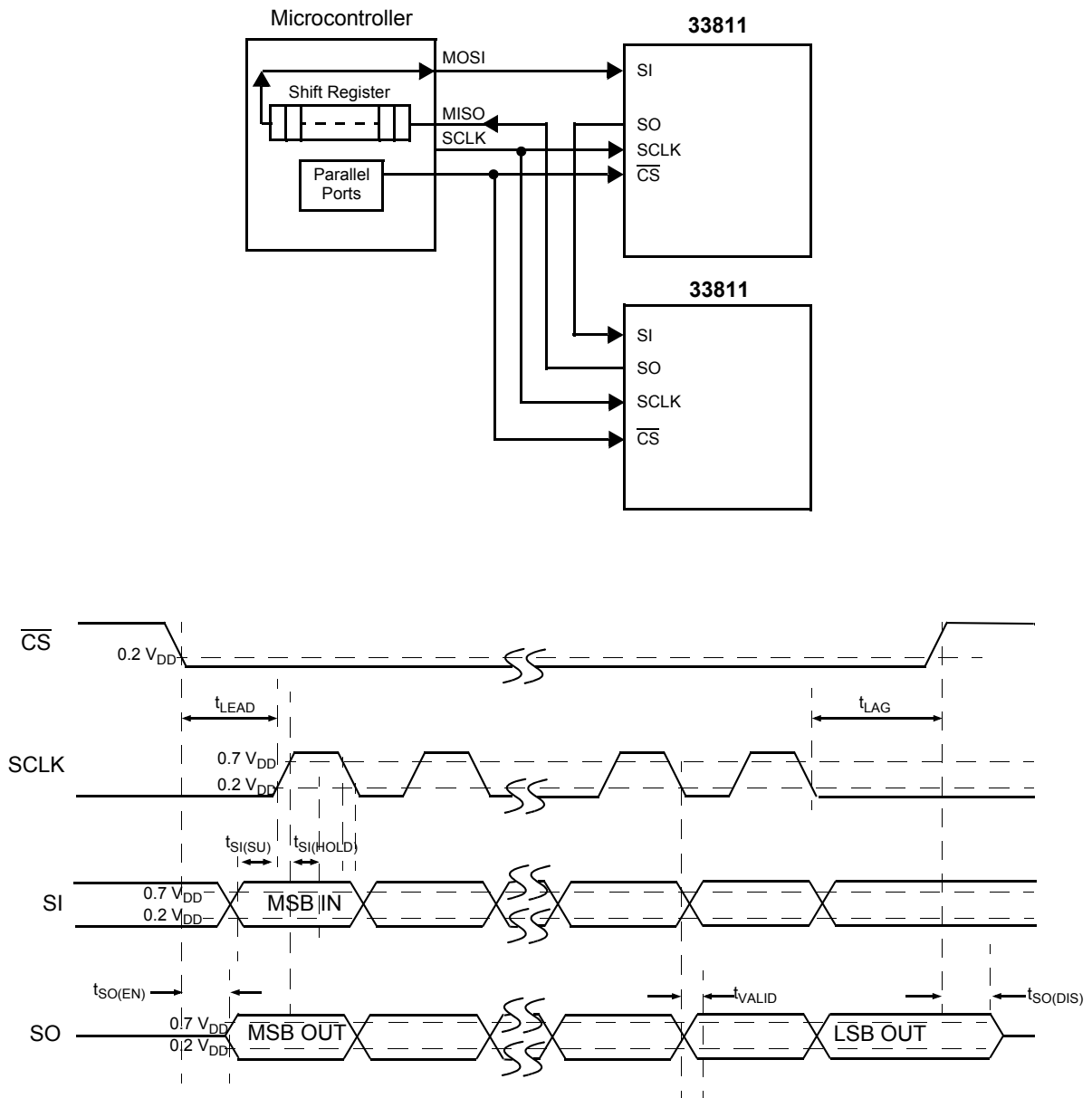


Figure 4. SPI Timing Characteristics

MICROCONTROLLER PARAMETRICS

SPI - MCU INTERFACE DESCRIPTION

The 33811 device directly interfaces to a 3.3V or 5.0V micro controller unit (MCU) using 16 bit Serial Peripheral Interface (SPI) protocol. SPI serial clock frequencies up to 3.2MHz may be used when programming and reading output status information (production tested at 3.2MHz). [Figure 5](#) illustrates the serial peripheral interface (SPI) configuration between an MCU and one 33811.

Command data is sent to the 33811 device through the SI input pin. As data is being clocked into the SI pin, status information is being clocked out of the device by the SO output pin. The response data received by the MCU during SPI communication depends on the previous SPI message sent to the device. Next SO response data is listed at the bottom of each command table.

SPI Integrity Check

Checking the integrity of the SPI communication with the initial power-up of the VDD and RESET pins is recommended. After initial system start-up or reset, the MCU will write one 16-bit pattern to the 33811. The first 8 bits read by the MCU will be the fault status (SO message 1) of the outputs. The second 8 bits will be the same bit pattern sent by the MCU. By the MCU receiving the same bit pattern it sent, bus integrity is confirmed. The second 16-bit pattern the MCU sends to the device is the a command word and will be operated on by the device accordingly on rising edge of \overline{CS} .

Important A SCLK pulse count strategy has been implemented to ensure integrity of SPI communications. SPI messages consisting of 16 SCLK pulses and multiples of 8 clock pulses thereafter will be acknowledged. SPI messages consisting of other than 16 + multiples of 8 SCLK pulses will be ignored by the device.

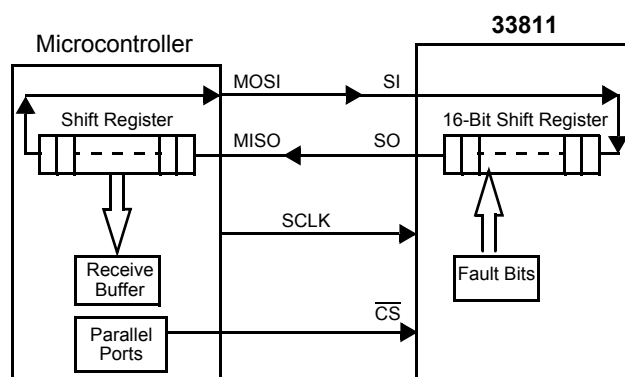


Figure 5. SPI Interface with Microprocessor

Two or more 33811 devices may be used in a module system. Multiple ICs may be SPI-configured in parallel or serial. [Figures 6](#) shows the configurations. When using the serial configuration, 32-clock cycles are required to transfer data in/out of the ICs.

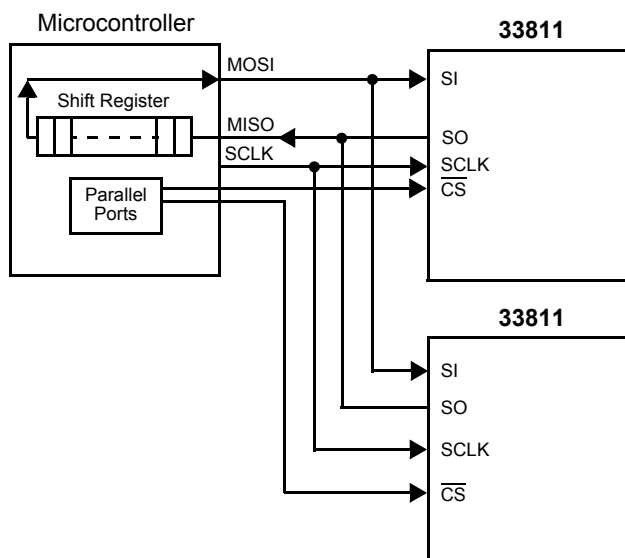


Figure 6. SPI Parallel Interface with Microprocessor

FUNCTIONAL DESCRIPTION

FUNCTIONAL PIN DESCRIPTION

ANALOG VOLTAGE SUPPLY (VPWR)

The VPWR pin is battery input to the 33811 IC. The VPWR pin requires external reverse battery and transient protection. Maximum input voltage on VPWR is 15.5V for full operation. All IC analog current is provided from the VPWR pin through an internal voltage regulator. The VPWR pin requires adequate decoupling capacitance to the A_GND pin.

DIGITAL VOLTAGE SUPPLY (VDD)

The VDD pin is Logic Supply input to the 33811 IC. Maximum input voltage on VDD is 5.25V for full operation. All IC digital logic current except the SPI SO output pin is provided from the VDD pin. The VDD pin requires adequate decoupling capacitance to the D_GND pin.

SPI INTERFACE VOLTAGE (VSPI)

The VSPI input pin is used to determine communication logic voltage levels between the microprocessor and the 33811 device. Current from VSPI is used to drive SO output and pull-up current for CS and SI. VSPI must be connected to +5 Volts or +3.3 Volts for normal operation.

ANALOG GROUND (A_GND)

The Analog Ground (A_GND) pin provides a low current analog ground for the IC. The VPWR supply is referenced to the A_GND pin. The A_GND pin should be used for decoupling the VPWR pin.

DIGITAL GROUND (D_GND)

The Digital Ground (D_GND) pin provides a dedicated ground for the VDD and VSPI supplies and should be connected to the A_GND pin.

SERIAL CLOCK INPUT (SCLK)

The system clock (SCLK) pin clocks the internal shift register of the 33811. The SI data is latched into the input shift register on the rising edge of SCLK signal. The SO pin shifts status bits out on the falling edge of SCLK. The SO data is available for the MCU to read on the rising edge of SCLK. With CS in a logic high state, signals on the SCLK and SI pins will be ignored and the SO pin is tri-state.

CHIP SELECT ($\overline{\text{CS}}$)

The system MCU selects the 33811 to receive communication using the chip select ($\overline{\text{CS}}$) pin. With the $\overline{\text{CS}}$ in

a logic low state, command words may be sent to the 33811 via the serial input (SI) pin, and status information is received by the MCU via the serial output (SO) pin. The falling edge of CS enables the SO output and transfers status information into the SO buffer.

Rising edge of the $\overline{\text{CS}}$ initiates the following operation:

1. Disables the SO driver (high-impedance)
2. Activates the received command word, allowing the 33811 to activate/deactivate output drivers.

To avoid any spurious data, it is essential the high-to-low and low-to-high transitions of the CS signal occur only when SCLK is in a logic low state. Internal to the 33811 device is an active pull-up to V_{SPI} on $\overline{\text{CS}}$. In cases where voltage exists on $\overline{\text{CS}}$ without the application of V_{SPI} , no current will flow from $\overline{\text{CS}}$ to the V_{SPI} pin.

SERIAL INPUT DATA (SI)

The SI pin is used for serial instruction data input. SI information is latched into the input register on the rising edge of SCLK. A logic high state present on SI will program a *one* in the command word on the rising edge of the $\overline{\text{CS}}$ signal. To program a complete word, 16 bits of information must be entered into the device.

SERIAL OUTPUT DATA (SO)

The SO pin is the output from the shift register. The SO pin remains tri-stated until the CS pin transitions to a logic low state. All normal operating drivers are reported as zero, all faulted drivers are reported as one. The negative transition of $\overline{\text{CS}}$ enables the SO driver.

The SI/SO shifting of the data follows a first-in-first-out protocol, with both input and output words transferring the most significant bit (MSB) first.

RESET INPUT (RESET)

The RESET pin is an active high digital input pin used to clear the fault outputs and registers in the device. During normal operation the RESET pin should be held low.

SOLENOID MONITOR INPUT (SOLM1, SOLM2, SOLM3, SOLM4, SOLM5)

These are the five solenoid monitor inputs that are connected to the Solenoid solenoid driver output pins.

FUNCTIONAL INTERNAL BLOCK DESCRIPTION

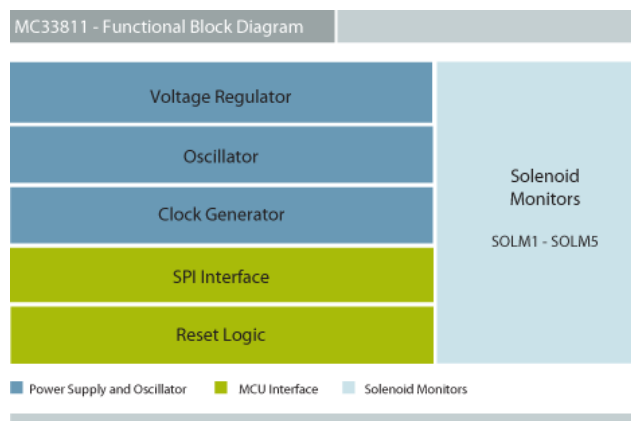


Figure 7. Functional Internal Block Diagram

POWER SUPPLY AND OSCILLATOR

The 33811 is designed to operate from 10.5V to 15.5V on the VPWR pin. The VPWR pin supplies power to the internal regulator which, in turn, supplies the analog circuit blocks. The VDD Supply is used internally to supply the logic circuitry. The VSP1 supply is used for setting the SPI communication threshold levels by supplying power to the SO driver and the SI and CS input buffers. The on-chip oscillator is used to set the solenoid sample period window and sample rate.

MCU INTERFACE:

The 33811 device directly interfaces to a 3.3V or 5.0V micro controller unit (MCU) using 16 bit Serial Peripheral Interface (SPI) protocol. SPI serial clock frequencies up to

3.2MHz may be used when programming and reading output status information. The RESET pin is used to place the 33811 into the Reset Mode. Normally the RESET pin is held at logic 0 by the MCU. When the MCU raises the RESET pin to a logic 1, the 33811 enters the reset Mode. The reset initializes the 5 fault outputs.

SOLENOID MONITORS: SOLM1 - SOLM5

These are the five solenoid monitor inputs that are connected to the external solenoid driver output pins. The IC has the ability to determine the correct movement of solenoid armatures by analyzing the variation in the voltage profile, across the solenoid driver MOSFET, which represents the actual solenoid current profile.

FUNCTIONAL DEVICE OPERATION

OPERATIONAL MODES

POWER SUPPLY

The 33811 is designed to operate from 10.5V to 15.5V on the VPWR pin. The VPWR pin supplies power to the internal regulator which, in turn, supplies the analog circuit blocks. The VDD Supply is used internally to supply the logic circuitry. The V_{SPI} supply is used for setting the SPI communication threshold levels by supplying power to the SO driver and the SI and CS input buffers. This IC architecture provides flexible microprocessor interfacing.

NORMAL MODE

The Normal Mode of operation occurs when the following conditions are met:

- 1) Device Junction Temperature is below 125°C.
- 2) V_{PWR} is >10.5V and < 15.5V
- 3) V_{DD} is > 4.75V and < 5.5V
- 4) A logic low (0) level is present on the RESET pin.
- 5) V_{SPI} is 3.3V or 5.0 Volts

The major function of the 33811 integrated circuit is provide the Engine or Transmission Control MCU with information about the status of up to five solenoids. When a solenoid is activated and operates properly, a unique current profile is produced. This current profile can be observed as a voltage waveform across the solenoid's low side driver MOSFET. The Solenoid Monitor inputs (SOLM1-5) on the 33811 are connected to voltage waveform monitoring circuits that are capable of discerning a properly opening and closing solenoid from one that is malfunctioning. When the 33811 determines that an solenoid is malfunctioning, a fault bit is set in the corresponding Solenoid SPI register. When the MCU interrogates the 33811 via the SPI, the solenoid fault will be annunciated by setting the appropriate SPI fault bit to a logic one (1).

SERIAL OUTPUT (SO) RESPONSE

All fault reporting is accomplished through the SPI interface. All logic [1]s received by the MCU from the SO pin indicate individual solenoid faults or the IC being held in the RESET mode. All logic [0]s received by the MCU from the SO pin indicate no fault, or normal operating solenoids. All fault bits are cleared on the positive edge of CS. SO bits 15, 14, 13, 12, and 11 represent the fault status of solenoids 4,3,2,1, and 5 respectively.

RESET MODE

The RESET pin is used to place the 33811 into the Reset Mode. Normally the RESET pin is held at logic 0 by the MCU.

When the MCU raises the RESET pin to a logic 1, the 33811 enters the Reset Mode causing two events to occur:

- 1) The internal Solenoid SPI register bits are cleared to 0.
- 2) The SO output pin is tri-stated, and pulled high by a pull-up resistor, causing all subsequent SPI Responses to contain all bits set to logic (1).

When the RESET pin is brought low again, the SO pin will be un-tri-stated and the SPI data will again reflect the data contained in the SPI register and the Solenoid fault register.

SPI COMMUNICATION

The 33811 integrated circuit communicates to the MCU via the SPI (Serial Peripheral Interface).

The SPI communication can be between one MCU and one 33811, or it can be between one MCU and several 33811 ICs.

The MCU can send two different SPI messages to the 33811, one 8 bits in length and one 16 bits in length. The 33811 responds by sending back 8 bit or 16 bit messages. When the MCU sends an 8 bit message to the 33811, the 33811 responds by sending only the 8 bit fault status. The fault status contains 5 bits of solenoid status and 3 bits of logic zeros. When the MCU sends a 16 bit interrogate message, the 33811 responds by sending the 8 bit fault status message followed by the last 8 previously sent bits.

The 33811 IC does not decode the SPI messages from the MCU. It will always respond in the same way, regardless of the contents of the 8 or 16 bits sent. Hence, no specific SPI commands are defined, and response is limited to either solenoid fault status alone, when an 8 bit message is sent, or the solenoid fault status along with the last 8 bits received when a 16 bit message is sent. The two SPI scenarios are outlined in the following diagrams.

SPI COMMUNICATION SUMMARY

1) The SPI communications sequence starts out in step 1 above with the contents of the MCU SPI shift register containing 8 bits of **x x x x x x x x** and 8 bits of **y y y y y y y y**. The 33811 SPI register contains a previous 8 bit byte of **p p p p p p p p** and the contents of the solenoid status register of **0 0 0 S5 S1 S2 S3 S4** is transferred into the SPI register. The condition shown is prior to the SPI transfer.

2) The MCU starts the transfer of data from its 16 bit SPI register to the 33811's SPI register by setting CS to a logic 0 and by issuing 16 SCLK pulses. At the end of the 16 SCLK pulses, the MCU brings CS back high to a logic 1. When the transfer is complete the MCU now contains the contents of the 33811's SPI register and the 33811 contains the contents of the MCU's SPI register.

3) Step 3 demonstrates an 8 bit SPI transfer. The same exchange is performed, however, only 8 SCLK pulses are issued and only 8 bits of data are exchanged.

4) When the transfer is complete, only the eight bits of solenoid status has been transferred to the MCU. The data in the 33811's SPI register lower 8 bits has been overwritten with the data from the MCU's SPI register.

5) Step 5 shows the same scenario as step 3 however, before the transfer, the RESET pin is brought to a logic 1. This causes all data out of the SO pin to be a logical 1.

6) This step shows the contents of the MCU SPI register after the transfer. All bits are logical 1 because the RESET pin was held high for the duration of the transfer

WAVEFORM DETECTION ALGORITHM

Three Stage Current Waveform

An operational solenoid, once activated, produces a current waveform that consists of three distinct regions. The three regions are categorized by their relationship to a "dip" in the current that occurs when the solenoid armature moves within the coil. The regions are labeled the "Pre-Dip", "Dip", and "Post-Dip" regions. At this point, it should be noted that the 33811 does not monitor this current directly. It monitors the voltage across the low-side MOSFET driver. When the MOSFET is turned on, it can be thought of, to a first approximation, as a resistor with value R_{DS} . Hence, any current variation through the solenoid, appears on the MOSFET drain, as a voltage variation, as is predicted by Ohm's law. The 33811 is designed to monitor the voltage across the MOSFET and determine if the solenoid is operational or faulty based on the voltage waveform that is produced.

Activation of the Solenoid

If the solenoid is not activated, the low side MOSFET driver is turned off, so almost the entire supply voltage appears across the MOSFET. When the MOSFET is activated, the voltage across it drops from the supply voltage to a voltage that depends on the instantaneous current flow through the solenoid and the R_{DS} of the MOSFET. This dramatic voltage swing from the supply voltage, to near ground, triggers a timer in the 33811 IC. The time value of this timer is labeled T_{BEGIN} and is 400 to 600 μ s in duration. If the voltage is still close to ground after T_{BEGIN} , then the solenoid is deemed to be activated and the waveform detection algorithm is started.

The PRE-DIP Region

After dropping to near ground, the voltage across the MOSFET starts to increase as the current through the

solenoid begins to increase. The "Pre-Dip" region consists of a positive slope region, leading to a voltage maxima or peak, followed by a negative slope region. The 33811 monitors this voltage ramp up by sampling the voltage every 72 μ s and comparing it to the previous sample. If the new sample exceeds the previous sample by 0.5mV or more, the sampling comparator's output is auto-zeroed to the new voltage level by adjusting the reference voltage to the input voltage and the sampling continues. At some point the voltage will reach a peak and the slope of the voltage curve will turn from positive to negative. The 33811 will continue sampling the voltage as it begins to descend but will not auto-zero the comparator until at least three consecutive samples of 3mV in magnitude have been detected.

The DIP Region

Once the three descending samples have been detected, sampling and auto-zeroing will continue to try to determine the next inflection point. This next inflection point will be the Dip which is caused by the successful travel of the solenoid's armature. If a Dip is not discovered within the total time window of 56 mS. then the solenoid will be said to be faulty and the appropriate SPI register fault bit will be set to a logic 1. If the inflection point is discovered then sampling will continue.

The Post-DIP Region

After the Dip has occurred the waveform detection algorithm will continue sampling the voltage for the remainder of the 56mS. time window. If the voltage is still increasing after three sample times, then the solenoid is deemed to be operational and the appropriate SPI register fault bit is cleared to a logic 0. The waveform detection logic is then reset back to a state where it look for the next solenoid activation event.

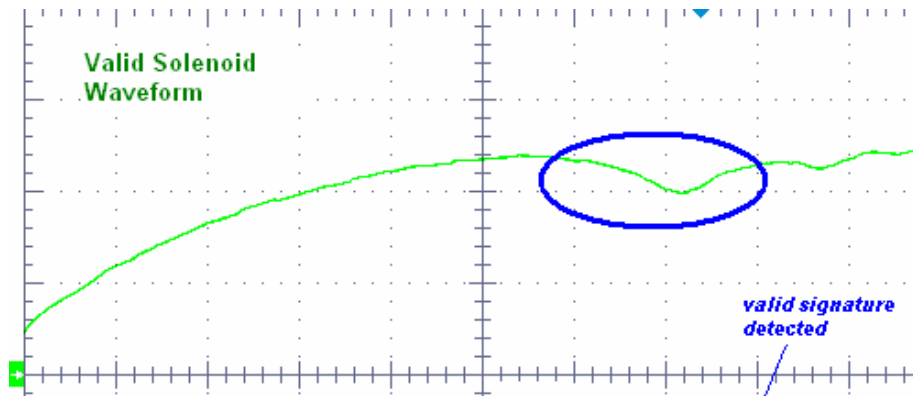
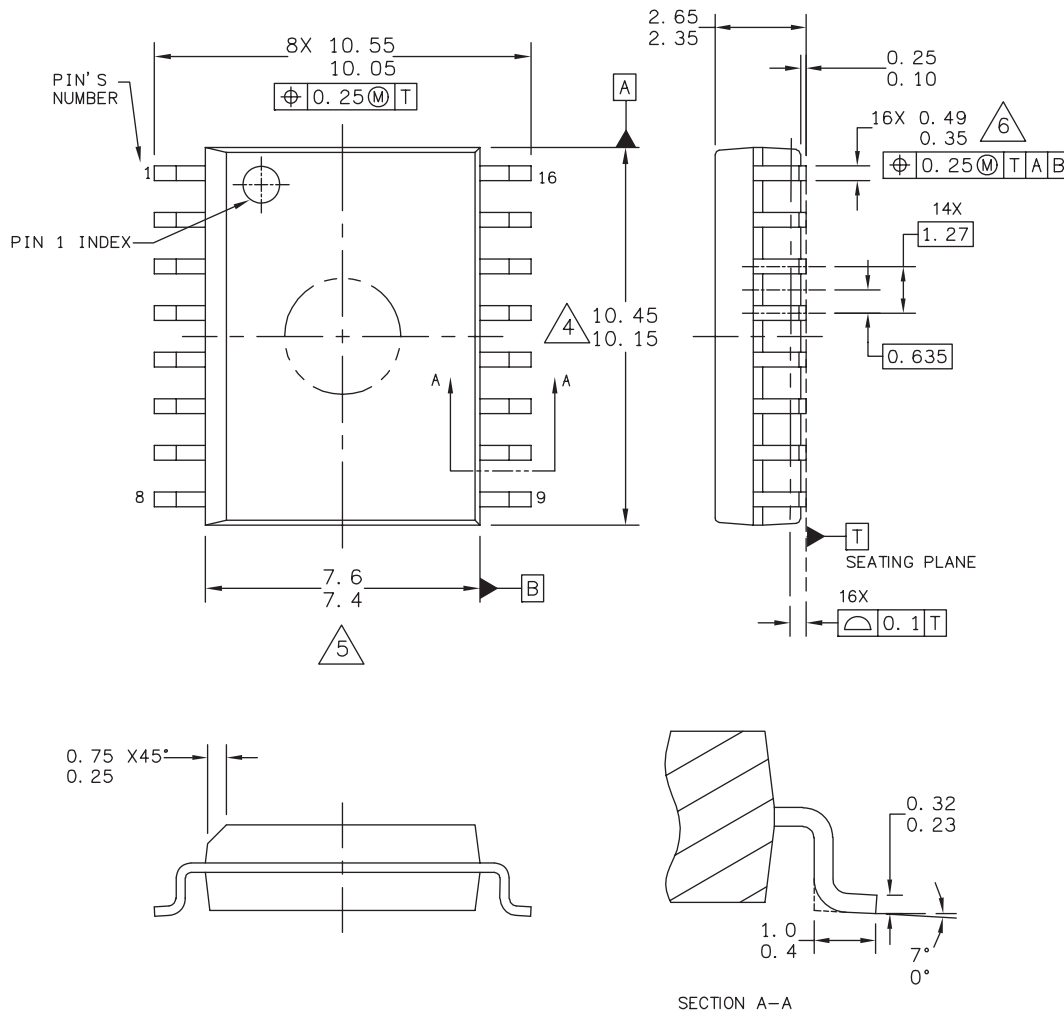


Figure 8. Valid Solenoid Waveform

PACKAGING

PACKAGE DIMENSIONS

For the most current package revision, visit www.freescale.com and perform a keyword search using the “98A” listed below.



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TITLE: 16LD SOIC W/B, 1.27 PITCH CASE-OUTLINE	DOCUMENT NO: 98ASB42567B	REV: F
	CASE NUMBER: 751G-04	02 JUN 2005
	STANDARD: JEDEC MS-013AA	

EG SUFFIX
16-PIN
PLASTIC PACKAGE
98ASB42567B
ISSUE F

REVISION HISTORY

REVISION	DATE	DESCRIPTION OF CHANGES
1.0	4/2007	<ul style="list-style-type: none">Initial ReleaseRemoved Peak Package Reflow Temperature During Reflow (solder reflow) parameter from Maximum Ratings on page 5.Added notes ⁽⁴⁾ and ⁽⁵⁾ to Maximum Ratings
2.0	7/2007	<ul style="list-style-type: none">Updates to form and style.
3	8/2008	<ul style="list-style-type: none">Changed Part Number on page 1 from PCZ to MCZ.Upgraded from Product Preview to Advance Information status.

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